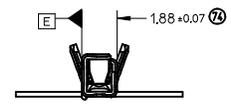
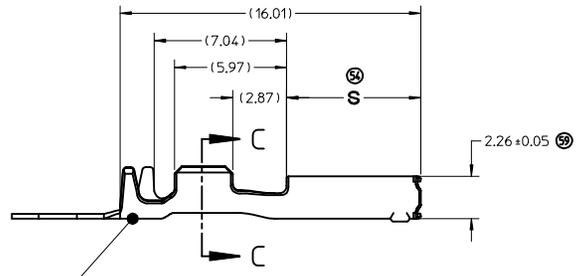
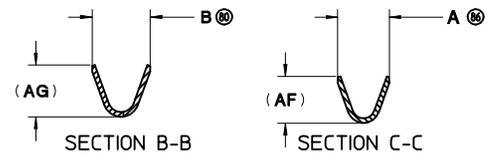
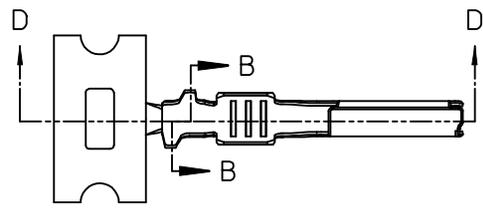
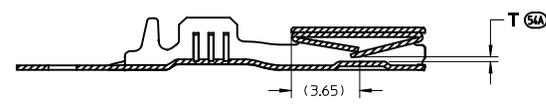
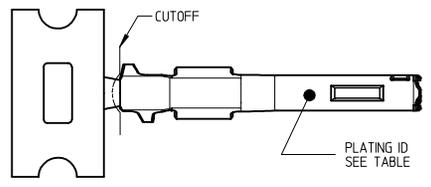


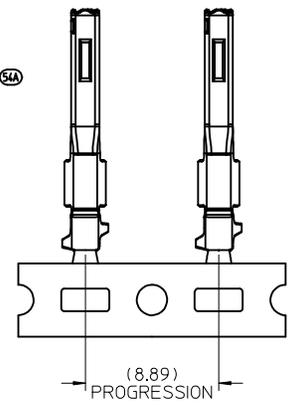
ISO VIEWS  
SCALE 3:1



TRADEMARK,  
DATE CODE,  
GRIP CODE



SECTION D-D



- NOTES: (UNLESS OTHERWISE SPECIFIED)
- MATERIALS: SEE TABLE
  - PACKAGING SPECIFICATION: PK-31300-516 AND PK-30907-759
  - CRIMPING PER APPLICATION SPECIFICATION AS-33468-002
  - CRIMPED LEAD MEETS THE FOLLOWING:
    - SAE/J1702-21, MAY 2002
    - SAE/J1702-2, REV. 3, APRIL 2001
    - SAE/J1702-12, REV. 2
    - GMW #3191 AUGUST 22, 2000 (DRAFT) TEMPERATURE CLASS 3, APPLIES ONLY TO Au PARTS
  - PLATING NOTES:
    - TIN PLATING (ENTIRE TERMINAL)
      - ELECTRO REFLOW 1.90 - 3.30 MICROMETERS TIN OVER 0.25 - 0.76 MICROMETERS NICKEL
    - GOLD PLATING
      - UNDERPLATE OVERALL 1.25-2.25 MICROMETERS DUCTILE SULPHAMATE NICKEL
      - ELECTRODEPOSITED GOLD 0.76 - 15 MICROMETERS IN CONTACT AREAS
      - ELECTRODEPOSITED TIN MATTE FINISH 25 - 4.0 MICROMETERS IN CRIMP AREA
    - SILVER PLATING
      - UNDERPLATE OVERALL 1.25-2.25 MICROMETERS DUCTILE SULPHAMATE NICKEL
      - ELECTRODEPOSITED PURE SILVER 99.5% PURITY SEMI-BRIGHT FINISH WITH NO BRIGHTENERS OR CHROMATES 1.9 - 3.3 MICROMETERS IN CONTACT AREAS
      - ANTI-TARNISH TREATMENT FOR SILVER PLATED AREA: SYNTHETIC HYDROCARBON CONTACT SURFACE FINISH OR EQUIVALENT
      - ELECTRODEPOSITED TIN MATTE FINISH 25 - 4.0 MICROMETERS IN CRIMP AREA

WIRE SIZE	GRIP CODE	PART NUMBER	REEL PAYOFF DIRECTION	DM A	DM B	DM S	DM T	DM AF	DM AG	BASE MATERIAL	PLATING ID
0.35 mm <sup>2</sup>	A	33468-0021	D	2.3	2.8	7.15 ± 0.10	0.26 ± 0.07	(2.1)	(2.5)	COPPER ALLOY	Sn Lead Free
		33468-0022	B								Au Lead Free
		33467-0021	D								Au Lead Free
		33467-0022	B								Ag Lead Free
		34736-0025	D	2.3	2.8	6.97 ± 0.07	0.26 ± 0.07	(2.1)	(2.5)	COPPER ALLOY	Sn Lead Free
		34736-0026	B								Ag Lead Free
0.5-0.75 mm <sup>2</sup>	B	33468-0023	D	2.7	3.1	7.15 ± 0.10	0.26 ± 0.07	(2.5)	(2.7)	COPPER ALLOY	Sn Lead Free
		33468-0024	B								Au Lead Free
		33467-0023	D								Au Lead Free
		33467-0024	B								Ag Lead Free
		34736-0027	D	2.7	3.1	6.97 ± 0.07	0.26 ± 0.07	(2.5)	(2.7)	COPPER ALLOY	Sn Lead Free
		34736-0028	B								Ag Lead Free

ENTER DESCRIPTION EC NO: UAU2012-0628 DRINKFERGUSON 2011/12/01 CHKD: APPR:BMOSER 2011/12/13 REV:	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE <b>MM ONLY</b>	SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	▽=0	mm INCH	DRAWN BY DATE KFERGUSON 2011/10/04	TITLE MX64 ISO RECEPTACLE TERMINAL	MOLEX INCORPORATED SD-33468-002 SHEET NO. 1 OF 1	
	▽=0	4 PLACES ± --- ± ---	CHECKED BY DATE			
	▽=0	3 PLACES ± --- ± ---	APPROVED BY DATE BMOSER 2011/11/01	MATERIAL NO. <b>SEE TABLE</b>	DOCUMENT NO.	
▽=0	2 PLACES ± 0.10 ± ---	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SIZE C	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
	1 PLACE ± 0.3 ± ---					
	ANGULAR ± 3 °					

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